

May 18, 2006

06-072

AUTHORIZE INCREASED EXPENDITURE AUTHORITY
FOR OPSIS ARCHITECTURE, LLP TO COMPLETE
ARCHITECTURAL PROJECT WORK FOR SYLVANIA
CAMPUS BOND PROGRAM.

PREPARED BY: Steven J. Hopf, Purchasing Manager

FINANCIAL
RESPONSIBILITY: Stephen E. Sivage, Director, Physical Plant Department

APPROVED BY: Randy McEwen, Vice President, Administrative Services
Dr. Preston Pulliams, District President

REPORT: At the March 15, 2001 meeting per Resolution 01-066, the Board awarded a contract to Opsis /Group Mackezie (now Opsis Architecture, LLP) to provide architectural services for the Sylvania Campus Capital Bond Construction Program. The costs for these services were estimated to be approximately \$2.2 million over the six year period of the program, based on the preliminary scope of work in March 2001.

At the April 15, 2004 meeting per Resolution 04-129, the Board authorized additional expenditure authority of \$1,375,000 to Opsis Architecture, LLP, to complete architectural services based upon the understanding of the scope of work at that time which included increased work scope on HVAC upgrades, power distribution and emergency power upgrades, and additional smaller renovations. Approved expenditure authority was then \$3,575,000.00

Currently, the scope of the work again needs to be adjusted to add several small ancillary projects, including the following: engineering for added mechanical upgrades, remodel work in the CC enrollment services area, remodel of automotive technology program space in AM, and biology greenhouse. The need for an additional authorization of \$50,000 has been identified to complete professional work for the Sylvania program.

RECOMMENDATION:

That the Board of Directors authorize additional expenditure authority of \$50,000 to Opsis Architecture to complete architectural services for the Sylvania Bond Program through the duration of the presently defined scope. The total expenditure authorization for this contract shall now be \$3,625,000. All expenditures for these services will be paid from Bond funding.